

5 Package Information

5.1 SHT1x (surface mountable)

Pin	Name	Comment
1	GND	Ground
2	DATA	Serial data, bidirectional
3	SCK	Serial clock, input
4	VDD	Supply 2.4 - 5.5 V
	NC	Remaining pins must be left unconnected

Table 10 SHT1x Pin Description

5.1.1 Package type

The SHT1x is supplied in a surface-mountable LCC (Leadless Chip Carrier) type package. The sensors housing consists of a Liquid Crystal Polymer (LCP) cap with epoxy glob top on a standard 0.8 mm FR4 substrate. The device is free of lead, Cd and Hg.

Device size is 7.42 x 4.88 x 2.5 mm (0.29 x 0.19 x 0.1 inch)
 Weight 100 mg

The production date is printed onto the cap in white numbers in the form ww.y. e.g. "351" = week 35, 2001.

5.1.2 Delivery Conditions

The SHT1x are shipped in 12mm tape at 100pcs or 400pcs.. Reels are individually labelled with barcode and human readable labels. The Lot numbers allow full traceability through production, calibration and test.

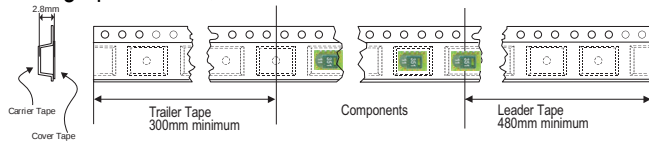


Figure 12 Tape configuration and unit orientation

5.1.3 Soldering Information

Standard reflow soldering ovens may be used. For details please see application note "soldering procedure".

For manual soldering contact time must be limited to 5 seconds at up to 350 °C.

After soldering the devices should be stored at >74 %RH for at least 24h to allow the polymer to rehydrate.

Please consult the application note "Soldering procedure" for more information.

5.1.4 Mounting Examples

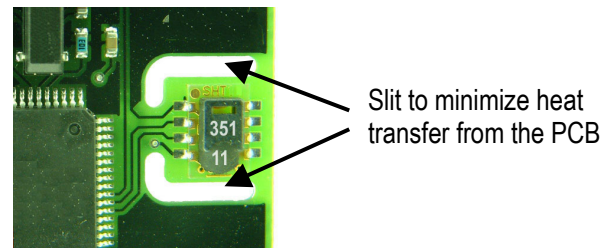


Figure 13 SHT1x PCB Mounting example

The SF1 membrane filter cap is available for optimal IP67 protection. When mounted through a housing the interior can be protected from the environment while still allowing high quality humidity measurements (see example below).

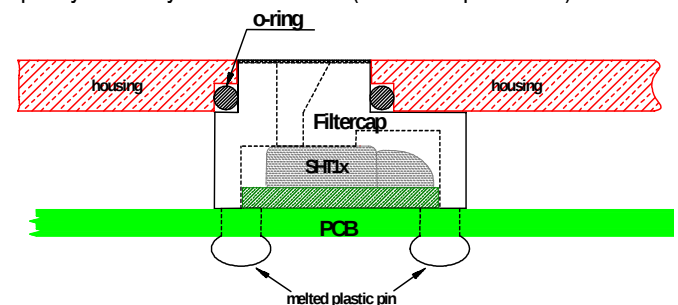


Figure 14 SF1 IP67 filter cap mounting example

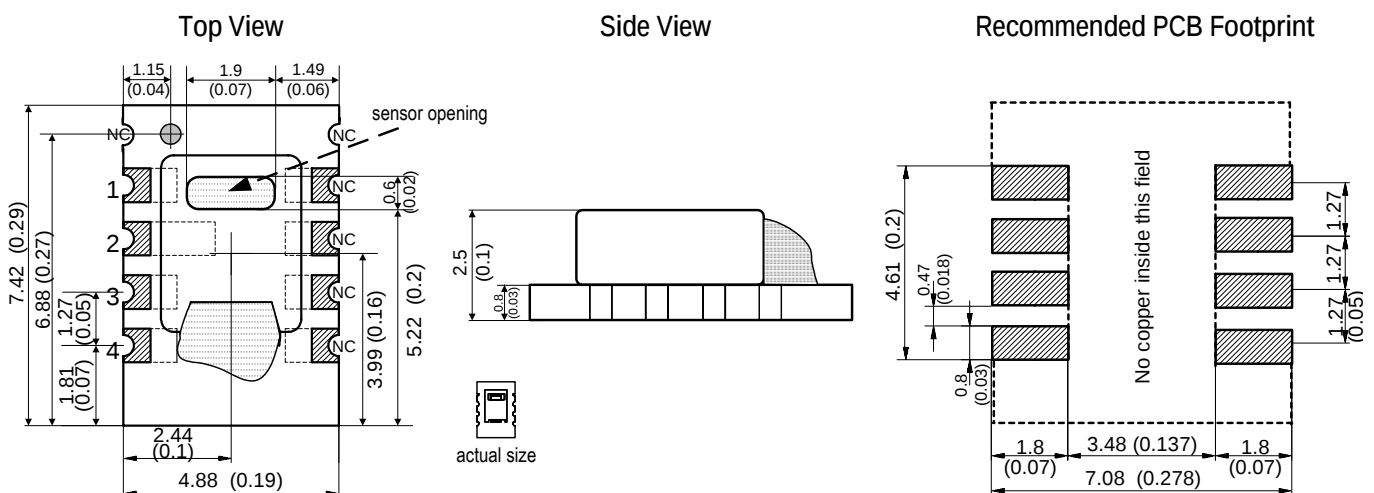


Figure 15 SHT1x drawing and footprint dimensions in mm (inch)